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Attorney Docket No. 0553-0393

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Shunpei YAMAZAKI et al

Serial No.: 10/757,167

Filed: January 13, 2004

Art Unit: 2812

For: METHOD FOR MANUFACTURING CONDUCTIVE)
LAYER AND SEMICONDUCTOR DEVICE)

) I hereby certify that this correspondence
) is being deposited with the United States
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) Commissioner for Patents, P.O. Box 1450,
) Alexandria, VA 22313-1450, on June 15,
2004

Cristie M. Hall

Date: June 15, 2004

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. §1.97, as revised on February 4, 1992, 1135 OG 23-24, Applicant hereby calls the Examiner's attention to documents listed on the attached form, which documents may be material to the examination of this application. As this application is being filed after June 30, 2003, pursuant to 37 CFR §1.491(b), copies of US patents and US patent application publications are not enclosed herewith. Copies of foreign patent documents and non-patent literature are enclosed herewith for the Examiner's consideration.

The family of JP 2002-359246 cited herein includes:
US Patent Application Publication no. US 2003/0054653 A1

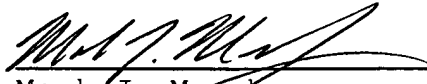
No inference should be drawn that the attached list sets forth a comprehensive investigation of the prior art, that any or all are pertinent to the invention, or that any apparatus disclosed is equivalent to the subject invention.

The citation of the above-discussed documents is not to be construed as an assertion that more pertinent art could not possibly be in existence. Citation of any document herein is not to be construed as an admission that any subject matter disclosed in the document is necessarily within the inventive field of endeavor, that any disclosure is necessarily prior in time to a particular date which may be relevant to the instant patent application, and/or that any disclosure is otherwise necessarily prior art with respect to the instant invention.

Applicant also respectfully reserves the right to later set forth how the instant invention is distinguished over the disclosure of any document or other art, including the disclosure of those documents discussed herein, that may be cited by the Examiner in rejecting a claim in the instant patent application.

A first office action, notice of allowance or issue fee notification has not been received in this case, so Applicant does not believe that a fee is due. However, if any such fee is required, please charge our Deposit Account No. 50/1039.

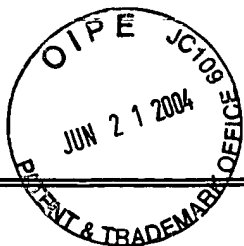
Respectfully submitted,

A handwritten signature in dark ink, appearing to read 'Mark J. Murphy', is written over a horizontal line.

Mark J. Murphy

Registration No.: 34,225

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LIST OF PUBLICATIONS CITED BY APPLICANT	<u>Atty Docket No.</u> 0553-0393	<u>Serial No.</u> 10/757,167
	<u>Applicant</u> Shunpei YAMAZAKI et al	
	<u>Filing Date</u> January 13, 2004	<u>Group</u> 2812

U. S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	US 2003/ 0054653 A1	03/20/03	Yamazaki et al	438	694	03/19/02

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE
	JP 2002- 324966	11/08/02	Harima Chem Inc.	X		04/24/01
	JP 2002- 359246	12/13/02	Semiconductor Energy Lab Co. Ltd	X		03/27/02

OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS

(Include name of author (in CAPITAL LETTERS), title of article or item (book, magazine, journal, serial, symposium, catalog, etc.) date, pages(s), volume-issue number(s), publisher, city and/or country where published).

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EXAMINER:	DATE CONSIDERED:
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*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.